10/016,844

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Ref #	Hits	Search Query	DBs	Default Operat or	Plura Is	Time Stamp
L1	36804	(B adj stag?\$4) or ((semi or partial\$2) adj (cured or curable or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:28
L2	38641	(B adj stag?\$4) or ((semi or partial\$2) adj (cure\$1 or curable or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:28
Ľ3	1716	semicure\$1 or semicurable or semiharden\$4 or semicrosslink\$	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:29
L4	14184	(I2 or I3) and adhesive	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:29

L5	45496	DSC or (differential adj scanning calorimetry)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:30
L6	635	l5 near10 (peak near5 exotherm\$2)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:30
L7	29	l4 and l6	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:42
L8	2	("6636816").PN.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/05/10 16:41
L9	214	(cure or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)) near5 (separate near5 separate\$2)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:48

L10	2	I4 and I9	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:47
L11	450520	lower near5 temperature	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:47
L12	447386	higher near5 temperature	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:48
L13	9422	(cure or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)) near5 l11	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 17:00
L14	9868	(cure or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)) near5 l12	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:48

L15	2162	l13 and l14	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:48
L16	243	I4 and I15	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:49
L17	765		US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:49
L18	106	I4 and I17	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:58
L19	522066	(two or 2) adj (part or component or pack\$4)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:59

L20	10370	l19 near7 adhesive	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 16:59
L21	376	120 and 14	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 17:00
L22	131583	(cure or curing or harden\$4 or crosslink\$4 or (cross adj link\$4)) near5 temperature	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 17:01
L23	2255	(separate\$2 or distinct or different) near7 l22	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 17:01
L24	2255	l22 and l23	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/05/10 17:02

L25	10	I21 and I23	US-PGPU B; USPAT; USOCR;	OR	ON	2005/05/10 17:05
			EPO;			
			JPO;			
			DERWEN			
			T;			
			IBM_TDB			